

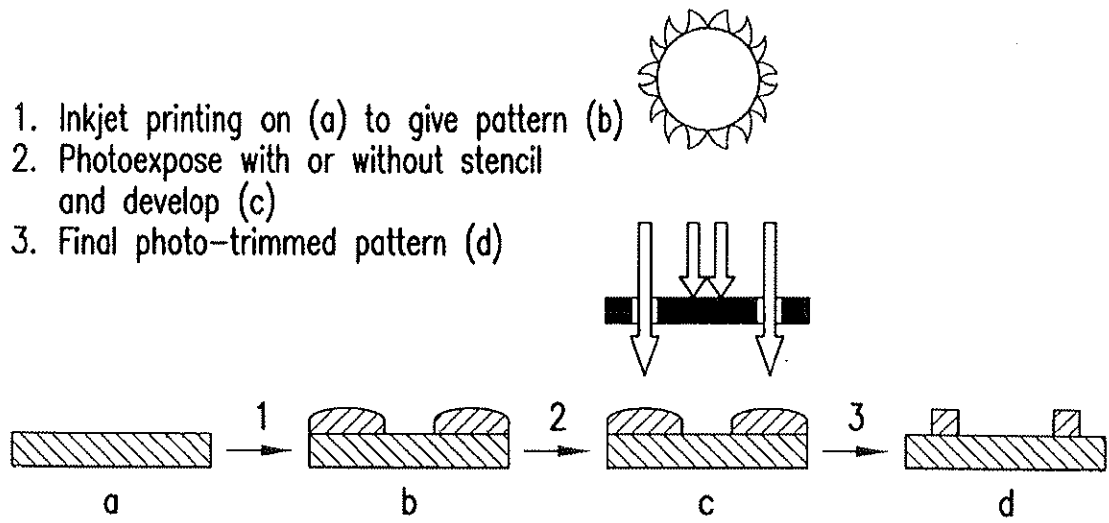


FIG.1

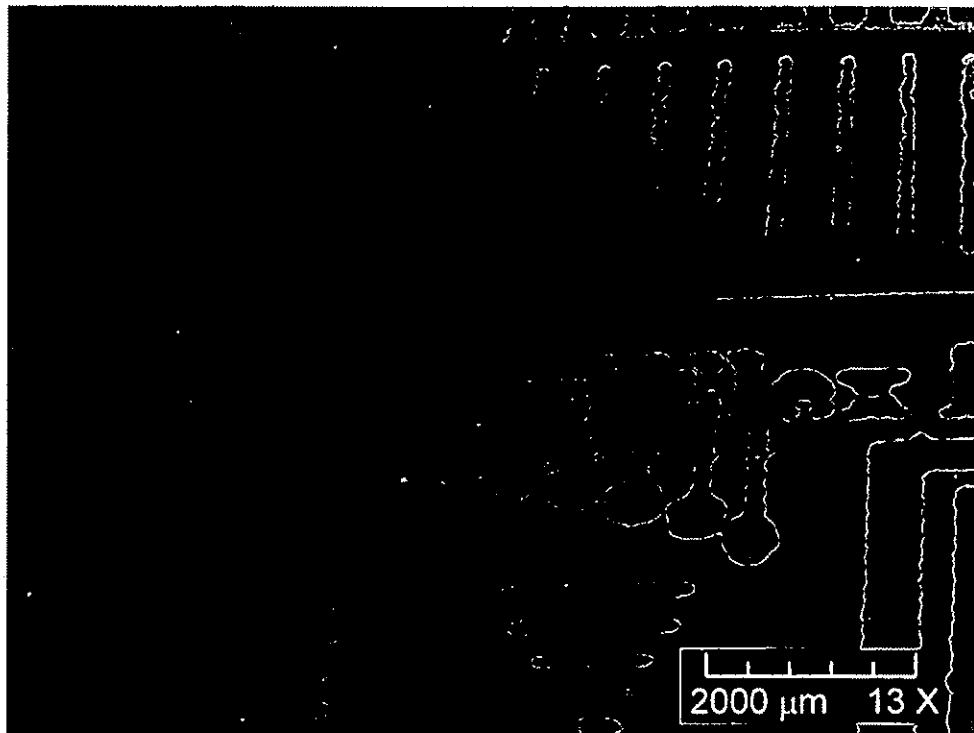


FIG.2

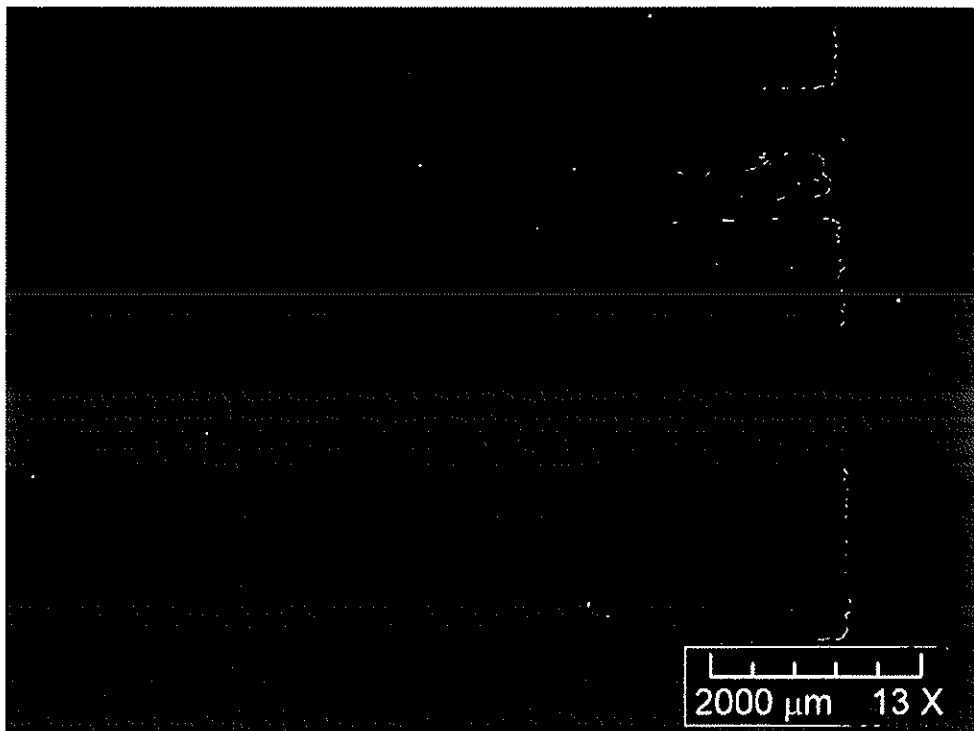


FIG.3

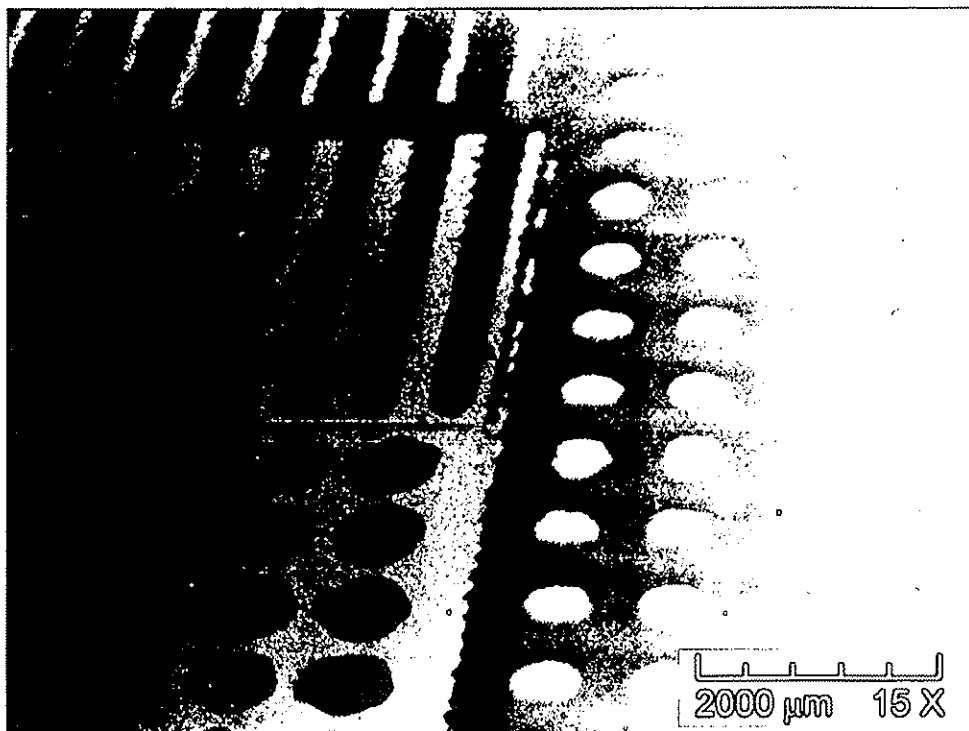


FIG.4

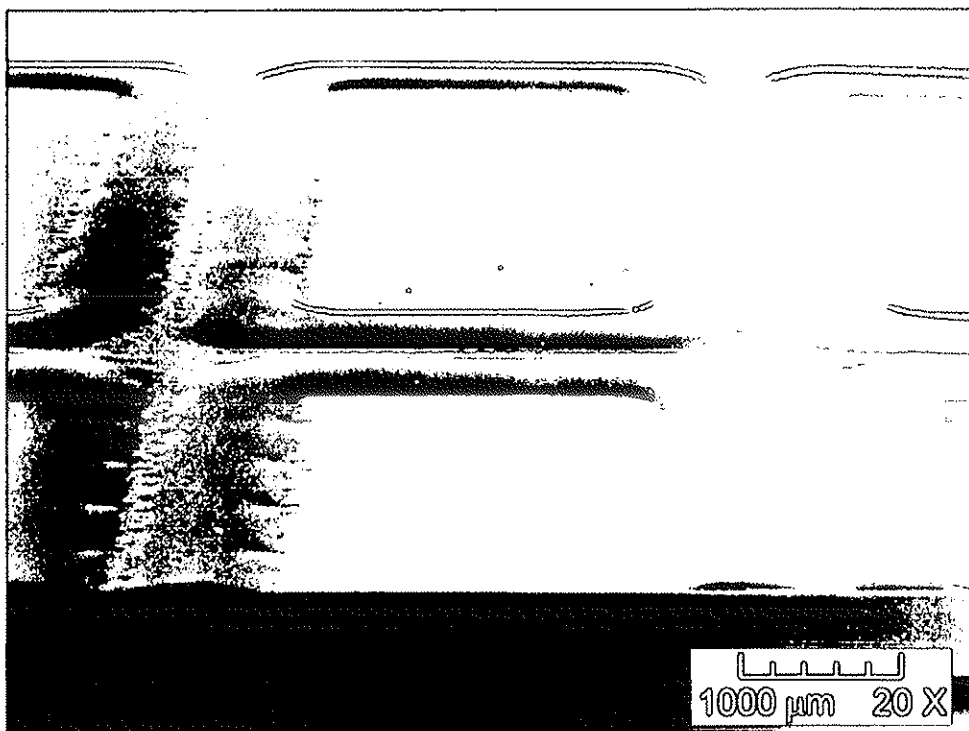


FIG.5

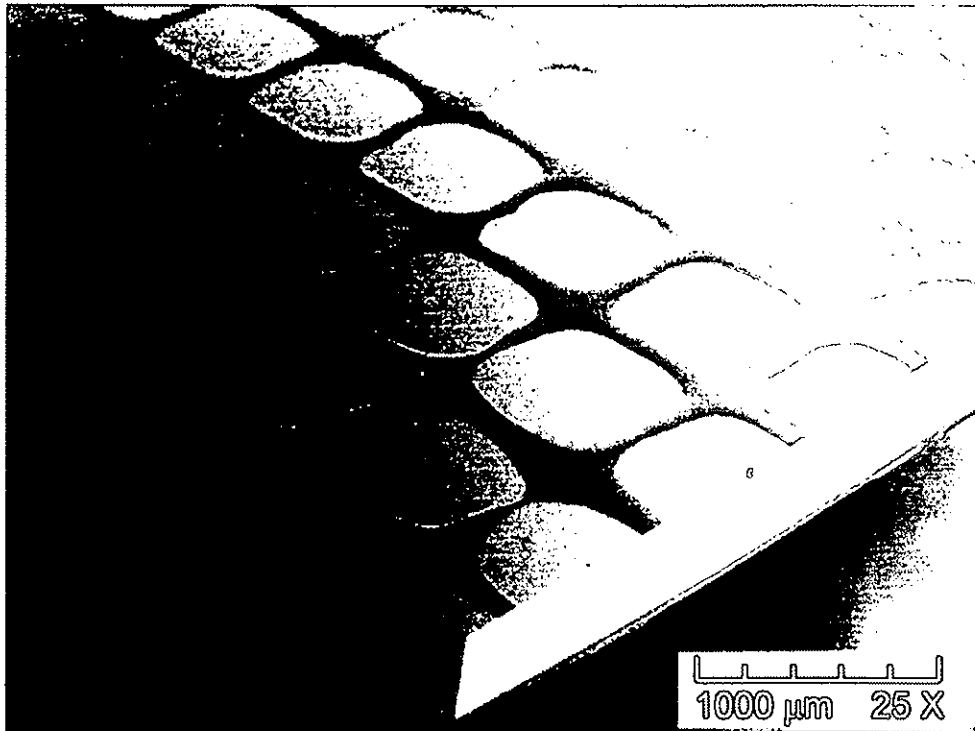


FIG.6

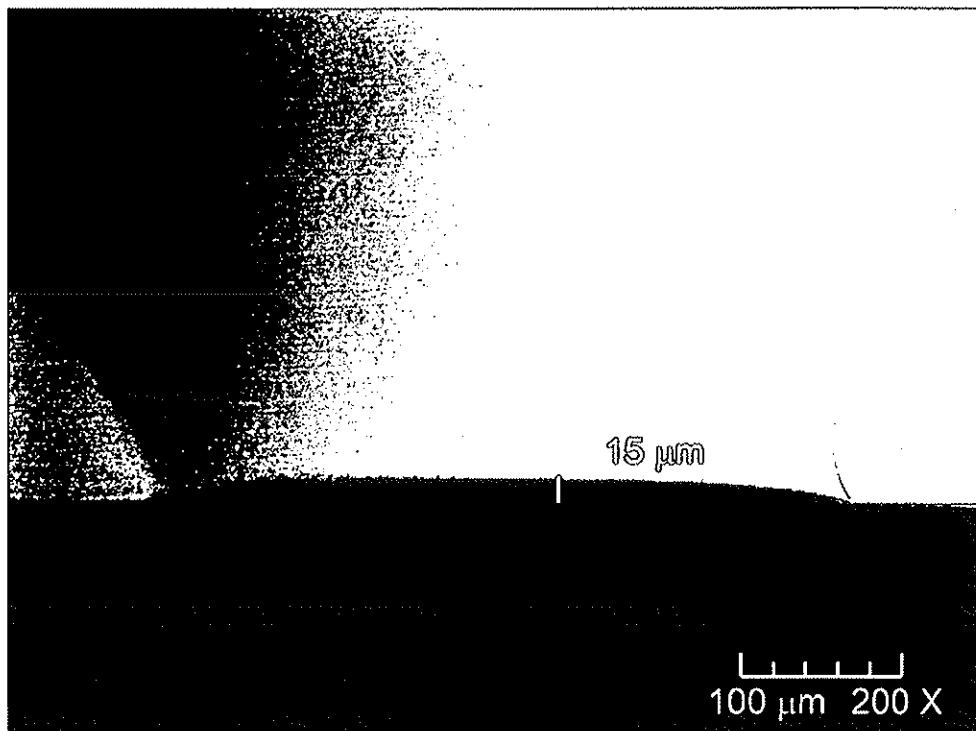


FIG.7

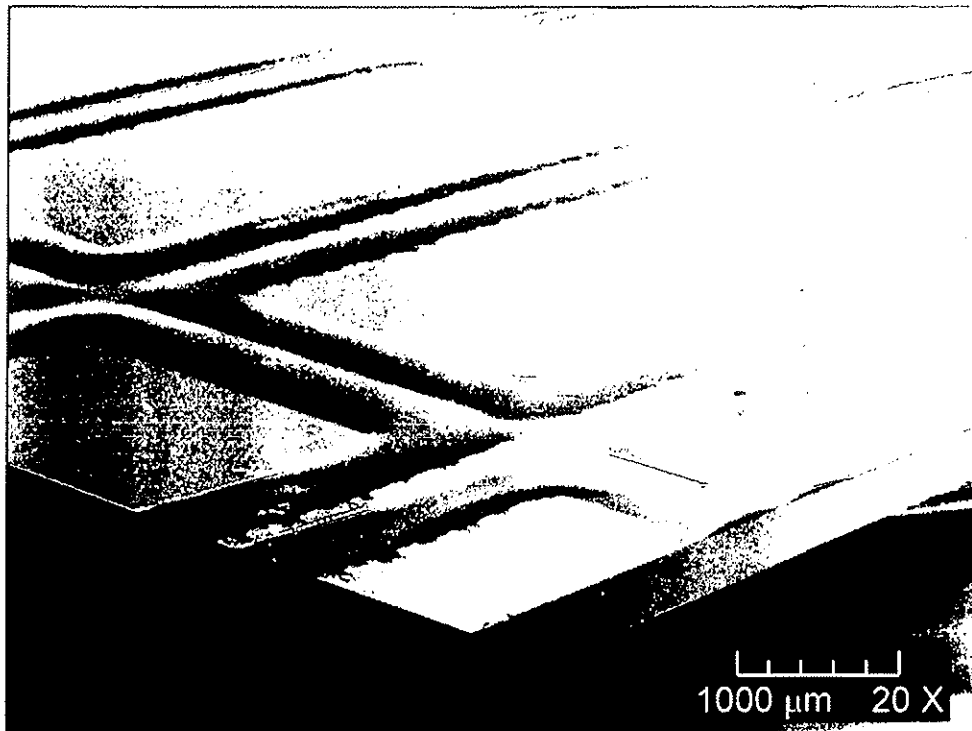


FIG.8

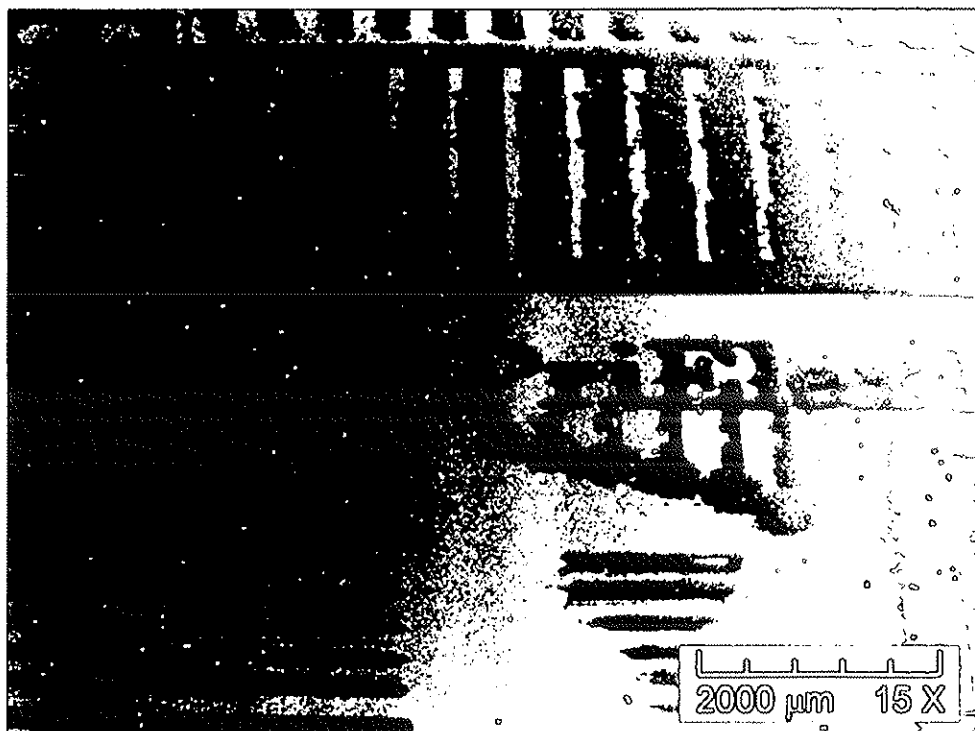


FIG.9

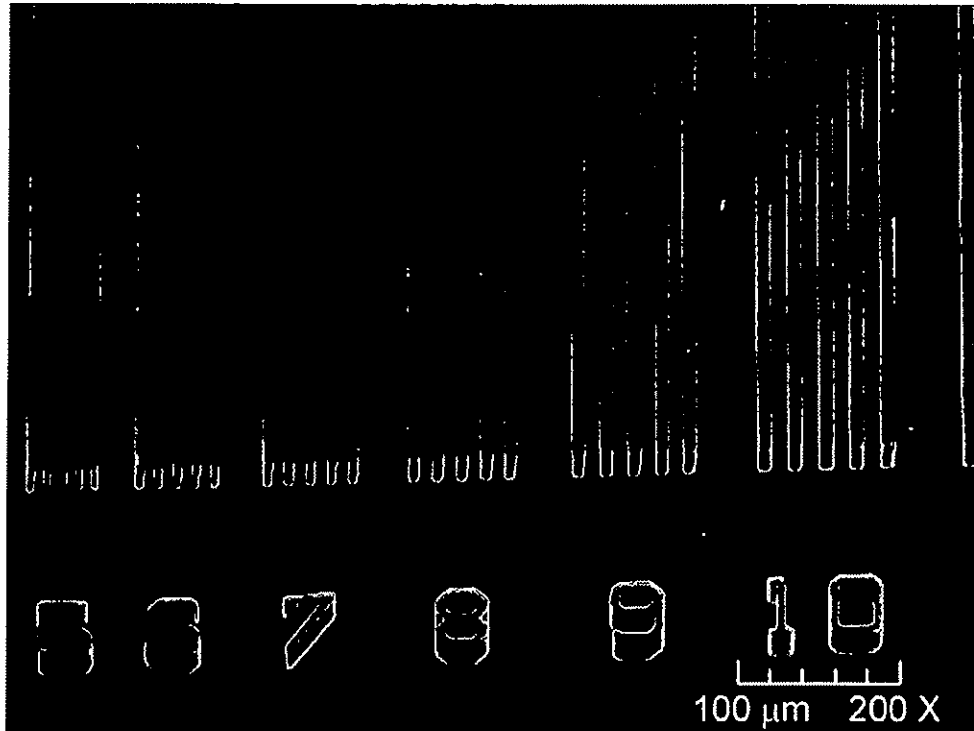


FIG.10

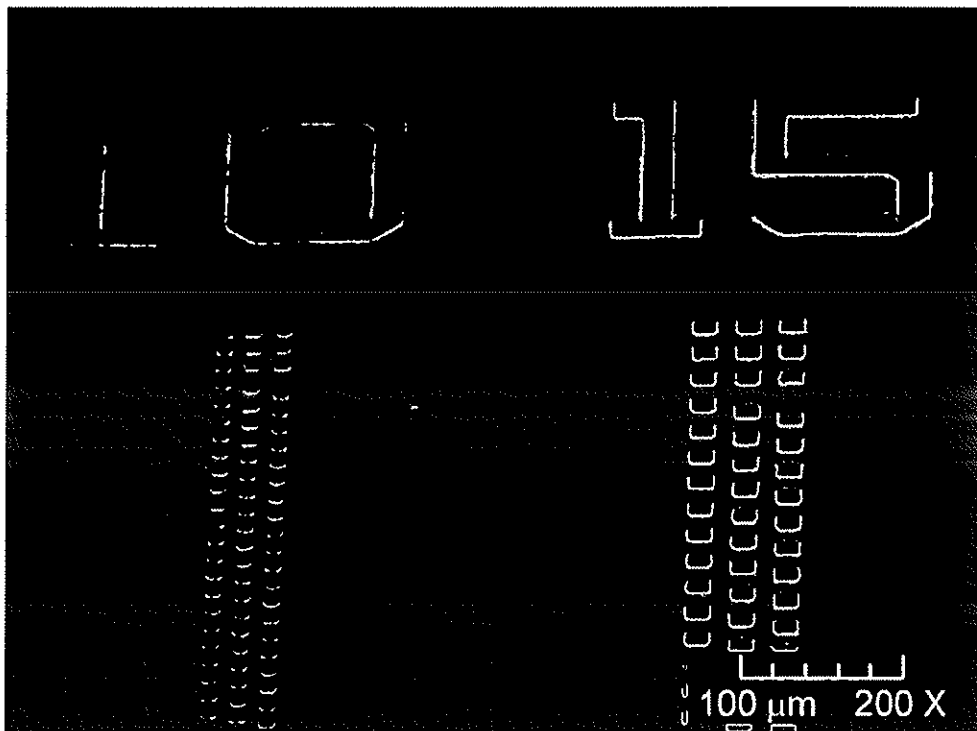


FIG.11

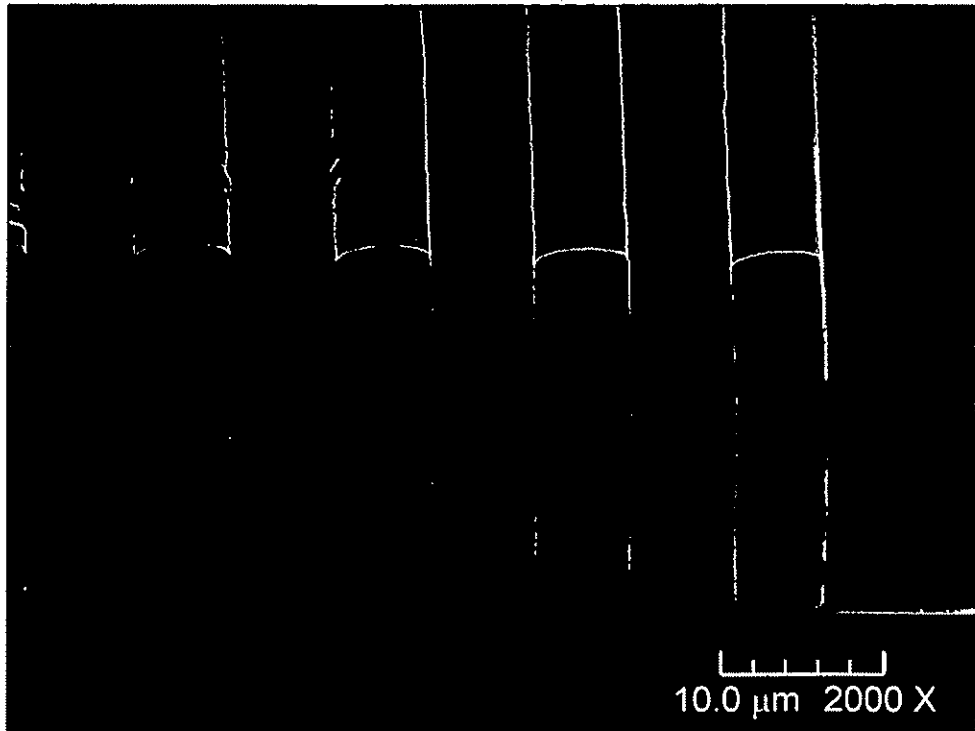


FIG.12

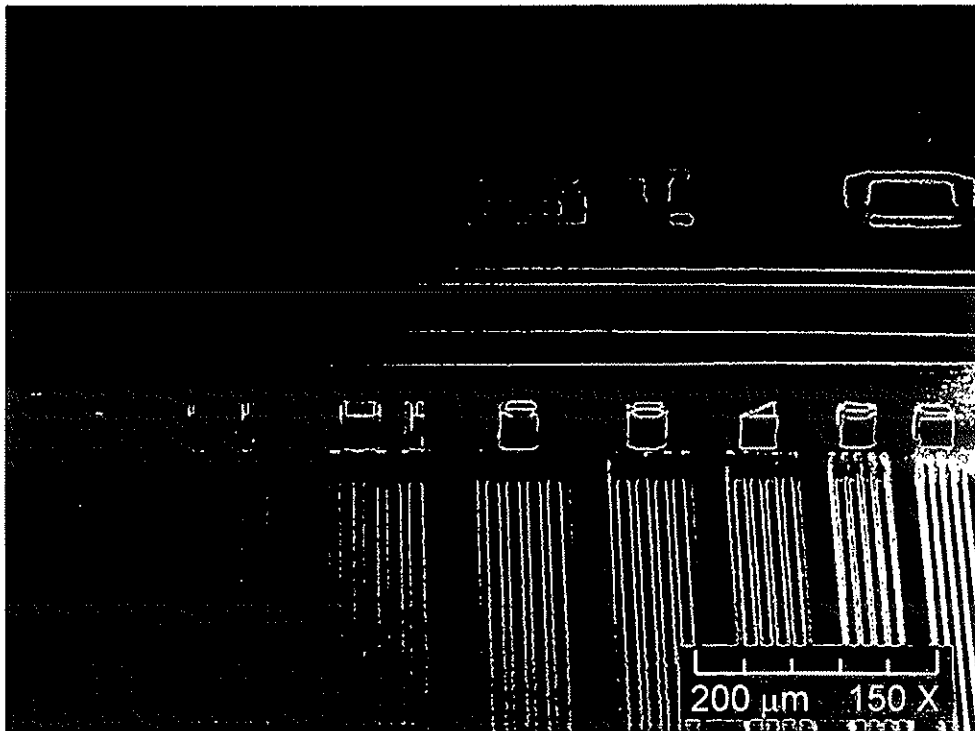


FIG.13

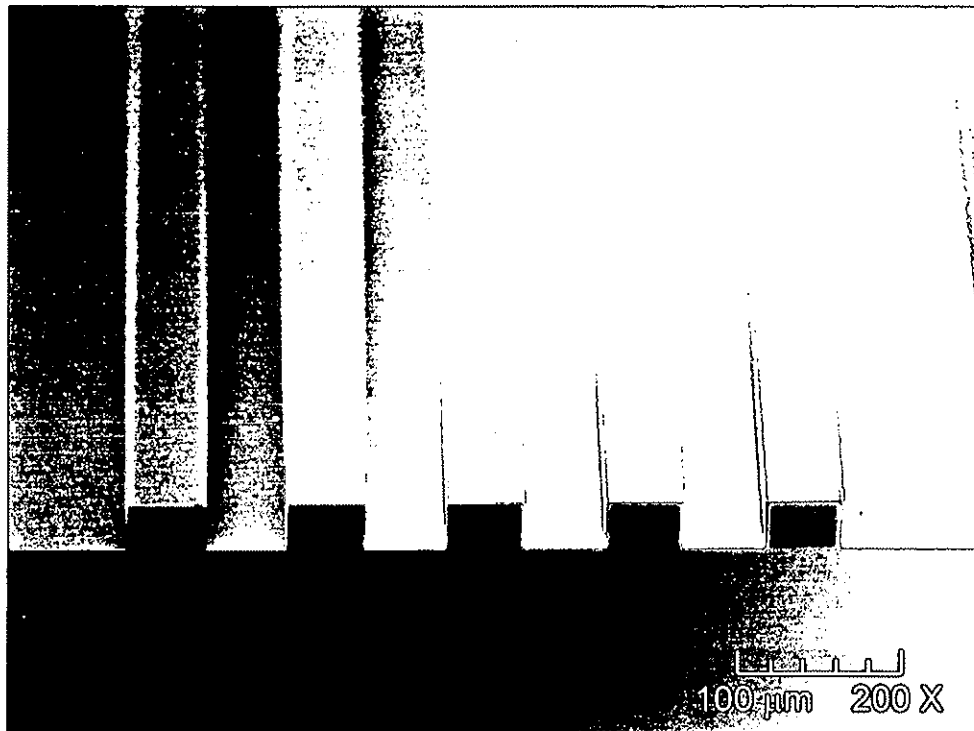


FIG.14

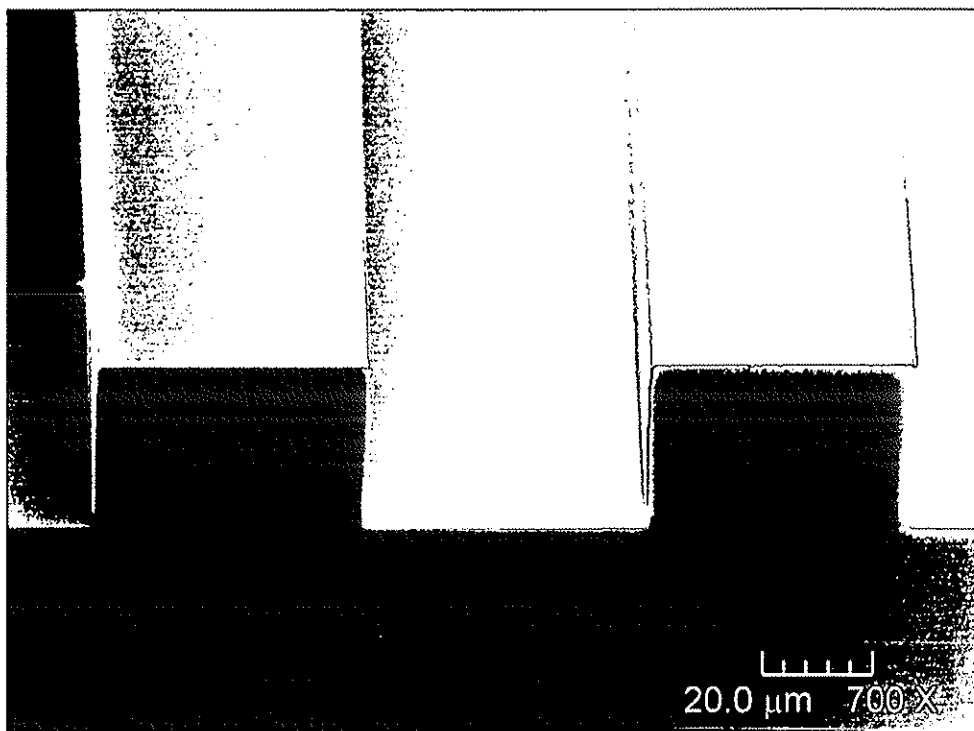
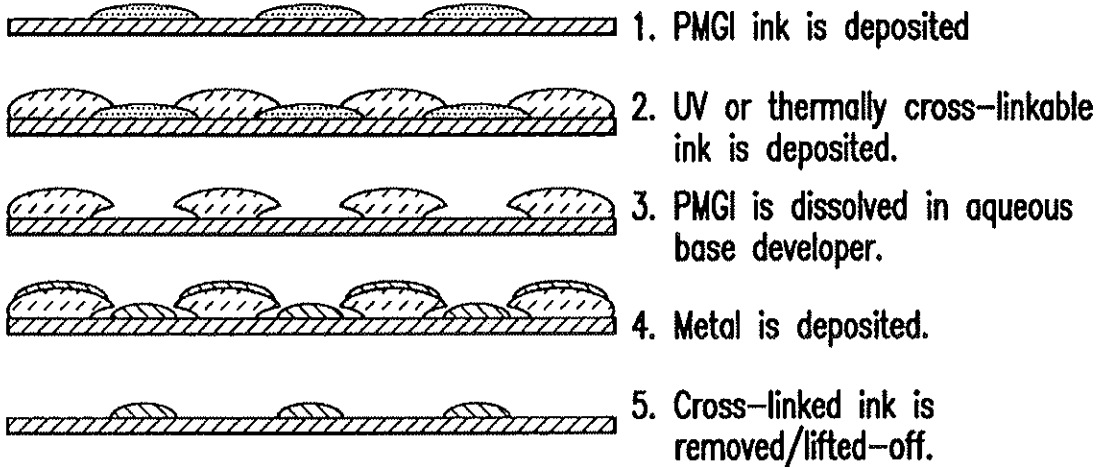
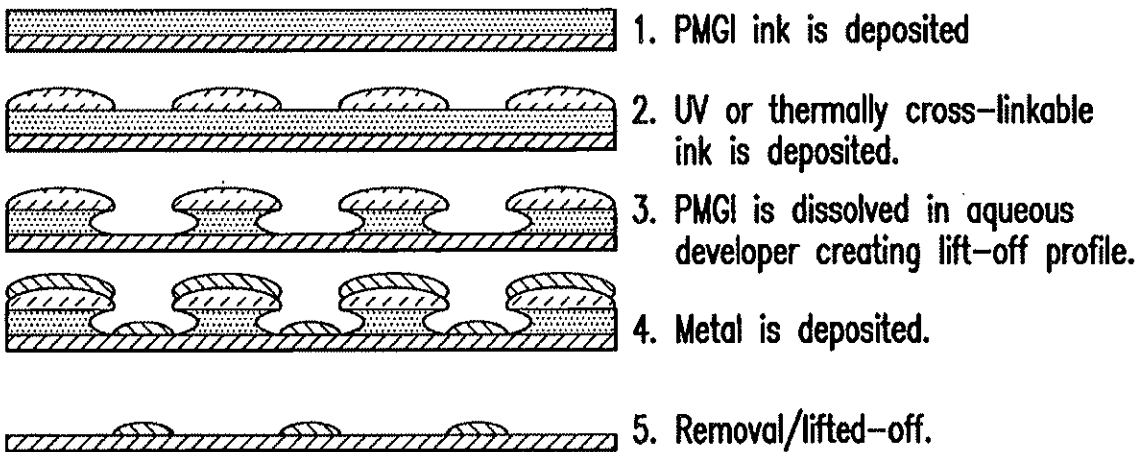


FIG.15

Lift-Off Process, Option 1



Lift-Off Process, Option 2

Underlayer

PMGI Ink – cure 110 °C for 1 min.

Top Layer

Epoxy Ink – cure 110 °C for 1 min.

Development Time - ~1 min.

2.38% TMAH Developer

FIG.16